

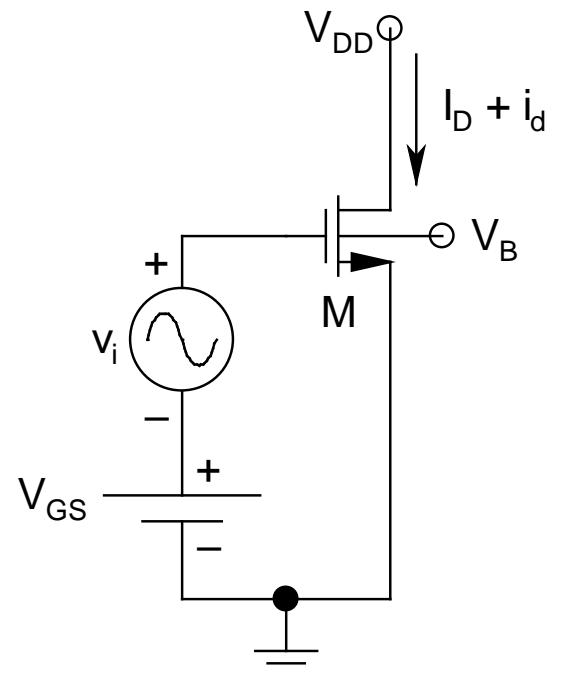
Small-Signal Model

- The *electrical equivalent* of the MOSFET at the *DC bias point*
- *Must be biased in saturation*
 - *Resembles a constant current source*
- *DC analysis must precede*, since *need the information regarding the Q-point* (I_D , V_{DS})
- *This model for NMOS and PMOS is the same (incremental model)*

Validity of the Small-Signal Model

- The *instantaneous current* (assuming $\lambda V_{DS} < 0.1$):

$$\begin{aligned} I_d &= \frac{k_N}{2} (V_{GT} + v_i)^2 \\ &= I_D + \frac{k_N}{2} [2V_{GT}v_i + v_i^2] \\ \Rightarrow i_d &= k_N V_{GT} v_i \left[1 + \frac{v_i}{2V_{GT}} \right] \end{aligned}$$



- Thus, for ***linear relationship*** between i_d and v_i , ***v_i must be << 2V_{GT}***
- Note that ***V_{GT} (minimum) = 3V_T***
- Hence, ***v_i should be less than 1/10th of 6V_T***
(requirement less rigorous than BJT)
- Recall in ***BJT***, for ***linear relationship*** between i_c and v_i , ***v_i has to be less than 1/10th of V_T***
 - ***Six times less than that for MOSFET***
 - ***MOSFETs are inherently more linear device than BJT (compare quadratic with exponential)***

Small-Signal Model Parameters

- *Transconductance* (g_m):

$$g_m \triangleq \left. \frac{\partial I_D}{\partial V_{GS}} \right|_{V_{DS} \text{ and } V_{SB} \text{ constant}}$$

$$= k_N V_{GT} (1 + \lambda V_{DS}) = \sqrt{2k_N I_D (1 + \lambda V_{DS})}$$

➤ *If $\lambda V_{DS} < 0.1$:*

$$g_m \approx k_N V_{GT} \approx \sqrt{2k_N I_D}$$

- An important ***Figure of Merit*** is ***transconductance to current ratio***
 - For **MOSFETs**: $g_m/I_D = 2/V_{GT}$
 - For **BJTs**: $g_m/I_C = 1/V_T$
 - Thus, ***BJTs produce more g_m per unit current***
- As we will see later, a ***high value of g_m is highly desirable***, since it ***dictates the gain***
- ***g_m/I_D can be changed by changing the bias current and/or aspect ratio***
- ***g_m/I_C is a function only of temperature***

- ***Body Transconductance*** (g_{mb}):

$$g_{mb} \triangleq \left. \frac{\partial I_D}{\partial V_{BS}} \right|_{V_{GS} \text{ and } V_{DS} \text{ constant}} = \chi g_m$$

$$\chi = \frac{\gamma}{2\sqrt{2\phi_F + V_{SB}}} = \textbf{Body factor} \quad (\sim 0.1\text{-}0.3)$$

- **Note:** As $V_{SB} \uparrow, V_{TN} \uparrow \Rightarrow I_D \downarrow$
- $\partial I_D / \partial V_{SB}$ would have yielded negative g_{mb}
- If both **B** and **S** are tied to fixed DC potentials (including ground), g_{mb} won't matter!

- *Output Conductance* (g_0)/

Output Resistance (r_0):

$$g_0 = r_0^{-1} \triangleq \left. \frac{\partial I_D}{\partial V_{DS}} \right|_{V_{GS} \text{ and } V_{SB} \text{ constant}} = \frac{\lambda I_D}{1 + \lambda V_{DS}}$$

➤ *If $\lambda V_{DS} < 0.1$:*

$$g_0 = 1/r_0 \approx \lambda I_D$$

➤ *λ has a very wide range* $\sim 0.01\text{-}0.5 \text{ V}^{-1}$

➤ *When $\lambda \rightarrow 0$, $g_0 \rightarrow 0$, and $r_0 \rightarrow \infty$*

- *Device starts to behave like an ideal constant current source*

- **Gate-Source and Gate-Drain Capacitance**

(C_{gs} and C_{gd}):

- Each has *two components*: *intrinsic* (i) and *technological* (t)

- *Total intrinsic gate-body capacitance*:

$$C_{gbi} = C'_{ox} WL$$

- Using *Meyer's model, intrinsic component*:

- In *linear region*: $C_{gsi} = C_{gdi} = C_{gbi}/2$

- In *saturation region*: $C_{gsi} = (2/3)C_{gbi}$, $C_{gdi} = 0$

- *Technology component arises due to gate-source and gate-drain overlap* (L_D)

➤ ***Technology components:***

$$C_{gst} = C_{gdt} = C'_{gs0} W = C'_{gd0} W$$

Gate-Source/Drain Overlap Capacitance

per unit width: $C'_{gs0} = C'_{gd0} = C'_{ox} L_D$

➤ Thus, ***total capacitance in saturation:***

$$C_{gs} = (2/3)C'_{ox} WL + C'_{gs0} W$$

$$C_{gd} = C'_{gd0} W$$

➤ $C_{gs} \gg C_{gd}$

- ***Source-Body and Drain-Body Capacitance*** (C_{sb} and C_{db}):

➤ ***Both reverse-biased n^+p junctions***

$$C_{sb} = \frac{C_{sb0}}{(1 + V_{SB}/V_0)^m} \quad \text{and} \quad C_{db} = \frac{C_{db0}}{(1 + V_{DB}/V_0)^m}$$

$$C_{sb0} = C_{sb} \Big|_{V_{SB}=0} \quad \text{and} \quad C_{db0} = C_{db} \Big|_{V_{DB}=0}$$

$$V_{SB} \text{ and } V_{DB} \geq 0$$

- ***Drain/Source Series Resistance*** (R_S and R_D):

➤ ***Due to neutral n^+ source/drain regions***